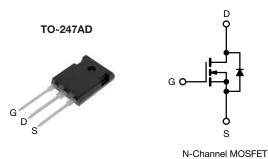
SiHW47N60EF



Vishay Siliconix

EF Series Power MOSFET with Fast Body Diode

| PRODUCT SUMMARY | | | | |
|--|-----------------|-------|--|--|
| V _{DS} (V) at T _J max. | 650 | | | |
| R _{DS(on)} max. at 25 °C (Ω) | $V_{GS} = 10 V$ | 0.065 | | |
| Q _g max. (nC) | 228 | | | |
| Q _{gs} (nC) | 32 | | | |
| Q _{gd} (nC) | 62 | | | |
| Configuration | Single | | | |



FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Increased robustness due to low Q_{rr}
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High-intensity lighting (HID)
 - Light emitting diodes (LEDs)
- Consumer and computing
- ATX power supplies
- Industrial - Welding
 - Battery chargers
- Renewable energy
- Solar (PV inverters)
- Switching mode power supplies (SMPS) · Applications using the following topologies

 - LLC
 - Phase shifted bridge (ZVS) - 3-level inverter
 - AC/DC bridge

| ORDERING INFORMATION | | | |
|---------------------------------|-----------------|--|--|
| Package | TO-247AD | | |
| Lead (Pb)-free and Halogen-free | SiHW47N60EF-GE3 | | |

| ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted) | | | | | | |
|--|---|-----------------------------------|-------------|-------|--|--|
| PARAMETER | SYMBOL | LIMIT | UNIT | | | |
| Drain-Source Voltage | | V _{DS} | 600 | v | | |
| Gate-Source Voltage | V _{GS} | ± 30 | v | | | |
| Continuous Drain Current (T _J = 150 °C) | $V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$ | | 47 | | | |
| | $T_{\rm C} = 100 ^{\circ}{\rm C}$ | ID ID | 29 | А | | |
| Pulsed Drain Current ^a | I _{DM} | 138 | | | | |
| Linear Derating Factor | | 3 | W/°C | | | |
| Single Pulse Avalanche Energy ^b | E _{AS} | 1500 | mJ | | | |
| Maximum Power Dissipation | PD | 379 | W | | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to +150 | °C | | |
| Drain-Source Voltage Slope | T _J = 125 °C | d\//dt | 70 | 1//20 | | |
| Reverse Diode dV/dt ^d | | dV/dt | 50 | V/ns | | |
| Soldering Recommendations (Peak Temperature) ^c | for 10 s | | 300 | °C | | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 73.5 mH, R_g = 25 Ω , I_{AS} = 6.4 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dl/dt = 500 A/µs, starting T_J = 25 °C

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RoHS COMPLIANT

HALOGEN

FREE



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| THERMAL RESISTANCE RATINGS | | | | |
|----------------------------------|-------------------|------|------|------|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
| Maximum Junction-to-Ambient | R _{thJA} | - | 40 | °C/W |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | 0.33 | C/W |

| PARAMETER | SYMBOL | TES | T CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|---|--|------|-------|-------|------|
| Static | | - | | • | • | • | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = 0 V, I _D = 250 µA | | 600 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Referenc | e to 25 °C, I _D = 1 mA | - | | - | V/°C |
| Gate-Source Threshold Voltage (N) | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | | 2.0 | - | 4.0 | V |
| | | | V _{GS} = ± 20 V | - | - | ± 100 | nA |
| Gate-Source Leakage | I _{GSS} | - | $V_{GS} = \pm 30 \text{ V}$ | | - | ± 1 | μA |
| | | | = 480 V, V _{GS} = 0 V | - | - | 1 | - μA |
| Zero Gate Voltage Drain Current | I _{DSS} | - | ′, V _{GS} = 0 V, T _J = 125 °C | - | - | 500 | |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | $I_D = 24 \text{ A}$ | - | 0.056 | 0.065 | Ω |
| Forward Transconductance | g _{fs} | | = 30 V, I _D = 24 A | - | 17 | - | S |
| Dynamic | 0.0 | | | | I | I | - |
| Input Capacitance | C _{iss} | | | - | 5000 | - | - |
| Output Capacitance | C _{oss} | - , | $V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz | | 220 | - | |
| Reverse Transfer Capacitance | C _{rss} | - | | | 7 | - | |
| Effective Output Capacitance, Energy Related ^a | C _{o(er)} | $V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$ | | - | 172 | - | pF |
| Effective Output Capacitance, Time Related ^b | C _{o(tr)} | | | - | 634 | - | |
| Total Gate Charge | Qg | | | - | 152 | 228 | nC |
| Gate-Source Charge | Q _{gs} | V _{GS} = 10 V | $V_{GS} = 10 \text{ V}$ $I_D = 24 \text{ A}, V_{DS} = 480 \text{ V}$ | - | 32 | - | |
| Gate-Drain Charge | Q _{gd} | | | - | 62 | - | |
| Turn-On Delay Time | t _{d(on)} | | | - | 30 | 60 | - ns |
| Rise Time | t _r | | = 480 V, I _D = 24 A, | - | 56 | 84 | |
| Turn-Off Delay Time | t _{d(off)} | V _{GS} = | $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.4 \Omega$ | | 91 | 137 | 115 |
| Fall Time | t _f | | | | 56 | 84 | |
| Gate Input Resistance | R _g | f = 1 MHz, open drain | | 0.2 | 0.46 | 1.0 | Ω |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 47 | |
| Pulsed Diode Forward Current | I _{SM} | | | - | - | 138 | A |
| Diode Forward Voltage | V _{SD} | T _J = 25 °C, I _S = 24 A, V _{GS} = 0 V | | - | 0.9 | 1.2 | V |
| Body Diode Reverse Recovery Time | t _{rr} | $T_{J} = 25 \text{ °C, } I_{F} = I_{S = 24 \text{ A}},$ dl/dt = 100 A/µs ^{, V} _R = 400 V | | - | 199 | 398 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | - | 1.4 | 2.8 | μC |
| Reverse Recovery Current | I _{RRM} | | | - | 13.2 | _ | A |

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

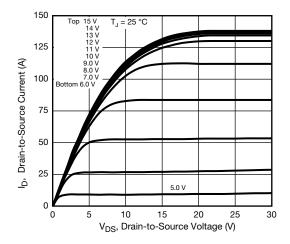


Fig. 1 - Typical Output Characteristics

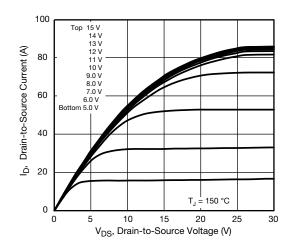
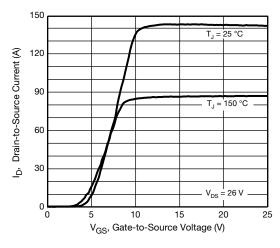


Fig. 2 - Typical Output Characteristics





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3.0 I_D = 24 A R_{DS(on)}, Drain-to-Source On Resistance (Normalized) 2.5 2.0 1.5 1.0 0.5 = 10 V V_{GS} 0.0 - 60 - 40 - 20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

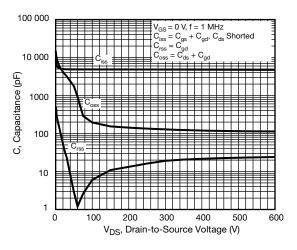


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

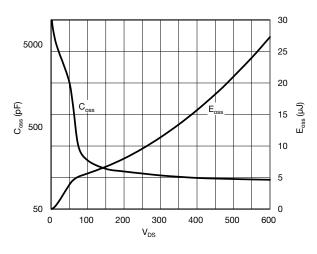


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

3 For technical questions, contact: <u>hvm@vishay.com</u>

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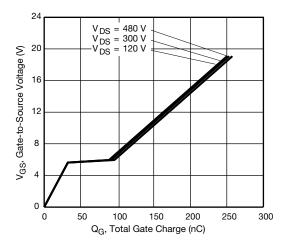


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

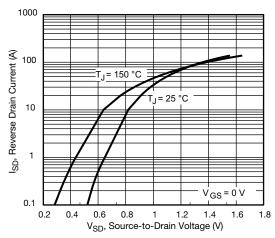


Fig. 8 - Typical Source-Drain Diode Forward Voltage

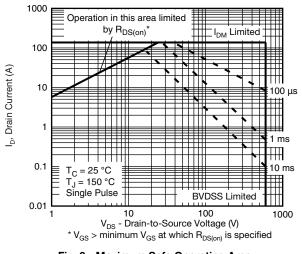


Fig. 9 - Maximum Safe Operating Area

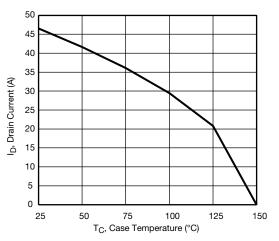


Fig. 10 - Maximum Drain Current vs. Case Temperature

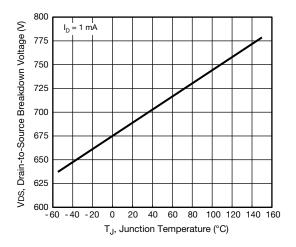
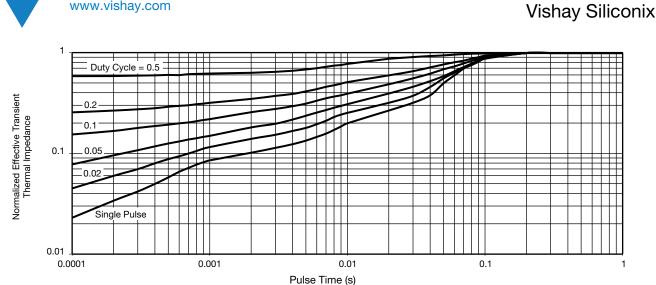
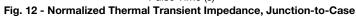
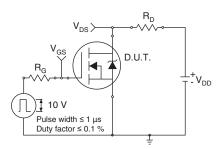


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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Fig. 13 - Switching Time Test Circuit

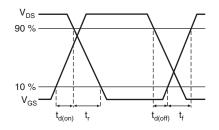


Fig. 14 - Switching Time Waveforms

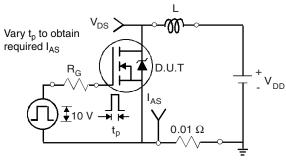


Fig. 15 - Unclamped Inductive Test Circuit

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V_{DS} V_{DD} V_{DS} I_{AS}

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Fig. 16 - Unclamped Inductive Waveforms

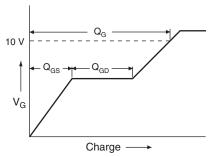


Fig. 17 - Basic Gate Charge Waveform

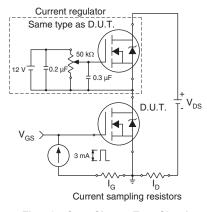


Fig. 18 - Gate Charge Test Circuit

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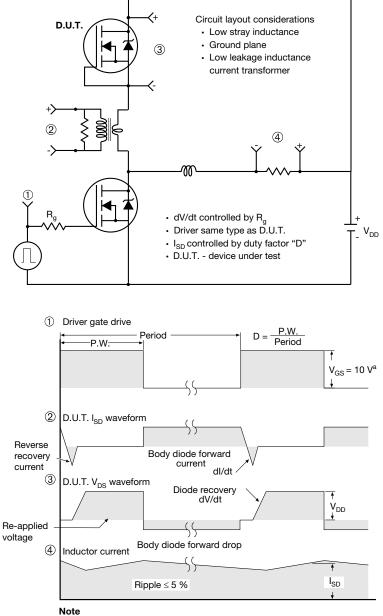
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

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